Description

The FQD20N06 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

Battery protection of in other Switching application



TO-252-2L

General Features

 $V_{DS} = 60V I_{D} = 20 A$

 $R_{DS(ON)} < 32m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply

PIN1 G PIN3 S

N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|------------|-----------|------------|----------|
| FQD20N06 | TO-252-2L | HXY MOSFET | 2500 |

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

| Symbol | Parameter | Rating | Units |
|---------------------------------------|--|-------------------------|-------|
| VDS | Drain-Source Voltage | Drain-Source Voltage 60 | |
| Vgs | Gate-Source Voltage | ±20 | V |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 20 | А |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 10 | А |
| МП | Pulsed Drain Current ² | 80 | А |
| EAS | Single Pulse Avalanche Energy ³ | 38 | mJ |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 34.7 | W |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C |



Electrical Characteristics (T_J = 25°C, unless otherwise noted)

| Parameter | | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---------------------------------------|-----------------------|----------------------|--|------|------|------|------|--|
| Static Characteristics | | | | • | | | | |
| Drain-Source Breakdown Vo | oltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 250μA | 60 | - | - | V | |
| Gate-Body Leakage Current | | lgss | V _{DS} = 0V, V _{GS} = ±20V | - | - | ±100 | nA | |
| Zero Gate Voltage Drain Current | TJ=25°C | | V _{DS} = 60V, V _{GS} = 0V | - | - | 1 | μA | |
| | TJ=100℃ | IDSS | | - | - | 100 | | |
| Gate-Threshold Voltage | | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 1.2 | 1.7 | 2.5 | V | |
| | | _ | V _{GS} = 10V, I _D = 10A | - | 25 | 32 | 0 | |
| Drain-Source on-Resistance | ,• | R _{DS(on)} | V _{GS} = 4.5V, I _D = 5A | - | 31.5 | 40 | mΩ | |
| Forward Transconductance ⁴ | | g fs | V _{DS} = 5V, I _D = 10A | - | 15.5 | - | S | |
| Dynamic Characteristic | s ⁵ | | | | | | | |
| Input Capacitance | | Ciss | | - | 1355 | - | | |
| Output Capacitance | | Coss | $V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$ | - | 60 | - | pF | |
| Reverse Transfer Capacitance | | Crss | - | - | 49 | - | | |
| Gate Resistance | | R _G | f=1MHz | - | 1.2 | - | Ω | |
| Switching Characteristi | CS ⁵ | | | • | | • | | |
| Total Gate Charge | | Qg | | - | 22 | - | nC | |
| Gate-Source Charge | | Q _{gs} | $V_{GS} = 10V, V_{DD} = 30V,$ $I_{D} = 10A$ | - | 4.2 | - | | |
| Gate-Drain Charge | | \mathbf{Q}_{gd} | | - | 6.9 | - | | |
| Turn-on Delay Time | | t _{d(on)} | | - | 6.4 | - | | |
| Rise Time | | tr | $V_{GS} = 10V, V_{DD} = 30V,$ | - | 15.3 | - | | |
| Turn-off Delay Time | | t _{d(off)} | $R_G = 3\Omega$, $I_D = 10A$ | - | 25 | - | ns | |
| Fall Time | | t _f | 1 | - | 7.6 | - | | |
| Body Diode Reverse Recovery Time | | trr | | - | 26 | - | ns | |
| Body Diode Reverse Recovery Charge | | Qrr | - I _F =10A, dI _F /dt=100A/μs | - | 45 | - | nC | |
| Drain-Source Body Dio | de Character | istics | • | | | | ı | |
| Diode Forward Voltage ⁴ | | V _{SD} | I _S = 10A, V _{GS} = 0V | - | - | 1.2 | V | |
| Continuous Source Current | T _C =25℃ | Is | - | - | _ | 20 | Α | |

Notes:

- 1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C
- 2. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.4mH, I_{AS} =14A
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 5. This value is guaranteed by design hence it is not included in the production test.



Typical Characteristics

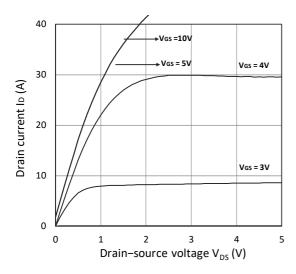


Figure 1. Output Characteristics

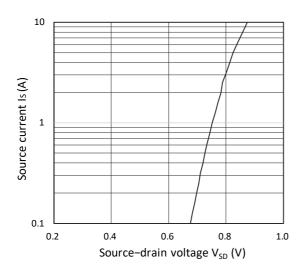


Figure 3. Forward Characteristics of Reverse

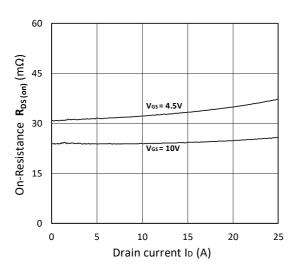


Figure 5. $R_{DS(ON)}$ vs. I_D

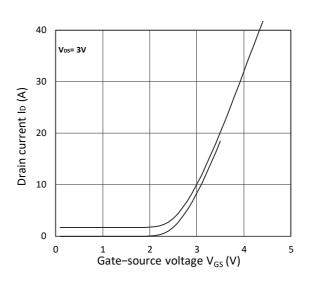


Figure 2. Transfer Characteristics

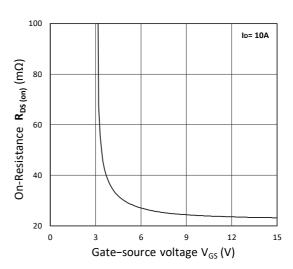


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

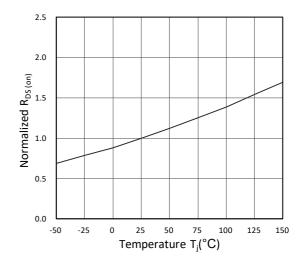


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

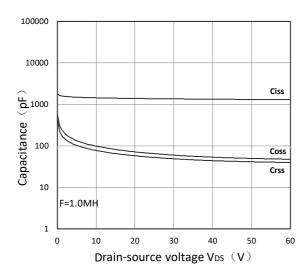


Figure 7. Capacitance Characteristics

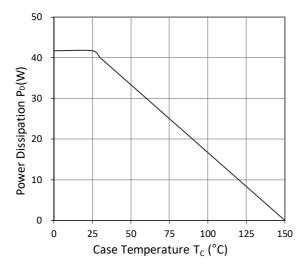


Figure 9. Power Dissipation

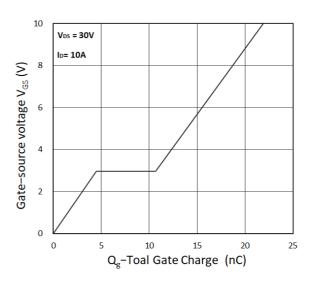


Figure 8. Gate Charge Characteristics

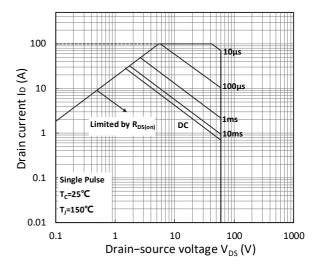


Figure 10. Safe Operating Area

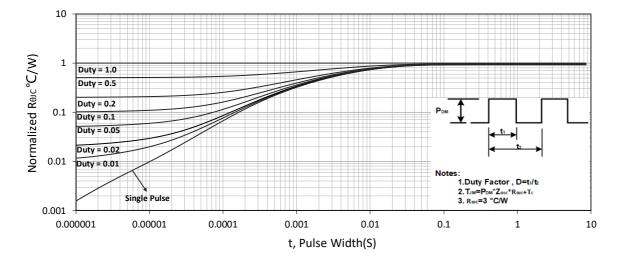
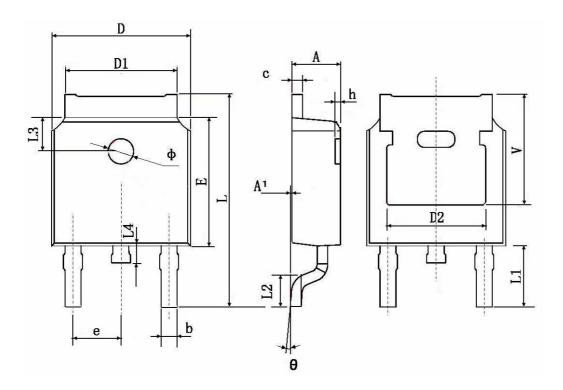


Figure 11. Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| А | 2.200 | 2.400 | 0.087 | 0.094 | |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 | |
| b | 0.660 | 0.860 | 0.026 | 0.034 | |
| С | 0.460 | 0.580 | 0.018 | 0.023 | |
| D | 6.500 | 6.700 | 0.256 | 0.264 | |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 | |
| D2 | 0.483 TYP. | | 0.190 TYP. | | |
| Е | 6.000 | 6.200 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.800 | 10.400 | 0.386 | 0.409 | |
| L1 | 2.900 TYP. | | 0.114 TYP. | | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 | |
| L3 | 1.600 TYP. | | 0.063 TYP. | | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 | |
| Ф | 1.100 | 1.300 | 0.043 | 0.051 | |
| θ | 0° | 8° | 0° | 8° | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| V | 5.350 TYP. | | 0.211 TYP. | | |



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